



BUZ11

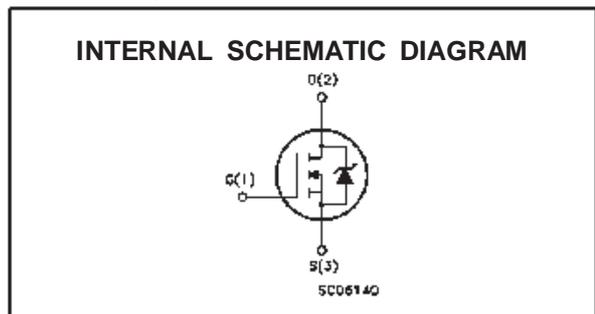
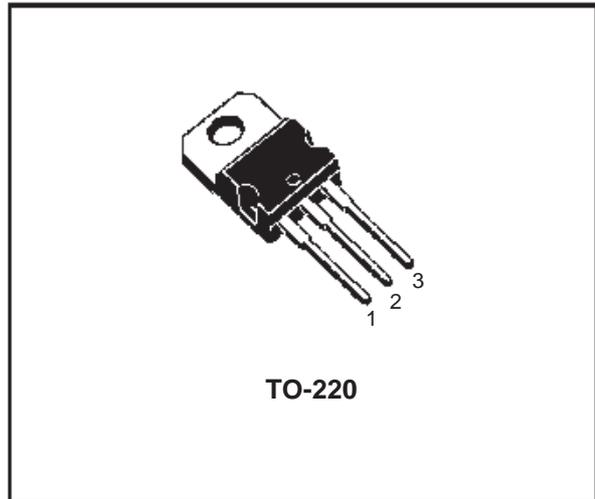
N - CHANNEL 50V - 0.03Ω - 33A TO-220 STripFET™ MOSFET

| TYPE | V _{DSS} | R _{DS(on)} | I _D |
|-------|------------------|---------------------|----------------|
| BUZ11 | 50 V | < 0.04 Ω | 33 A |

- TYPICAL R_{DS(on)} = 0.03 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- HIGH CURRENT CAPABILITY
- 175°C OPERATING TEMPERATURE

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|--|------------|------|
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 50 | V |
| V _{DGR} | Drain- gate Voltage (R _{GS} = 20 kΩ) | 50 | V |
| V _{GS} | Gate-source Voltage | ± 20 | V |
| I _D | Drain Current (continuous) at T _c = 25 °C | 33 | A |
| I _{DM} | Drain Current (pulsed) | 134 | A |
| P _{tot} | Total Dissipation at T _c = 25 °C | 90 | W |
| T _{stg} | Storage Temperature | -65 to 175 | °C |
| T _j | Max. Operating Junction Temperature | 175 | °C |
| | DIN HUMIDITY CATEGORY (DIN 40040) | E | |
| | IEC CLIMATIC CATEGORY (DIN IEC 68-1) | 55/150/56 | |

First digit of the datecode being Z or K identifies silicon characterized in this datasheet.

BUZ11

THERMAL DATA

| | | | | |
|-----------------------|-------------------------------------|-----|------|------|
| R _{thj-case} | Thermal Resistance Junction-case | Max | 1.67 | °C/W |
| R _{thj-amb} | Thermal Resistance Junction-ambient | Max | 62.5 | °C/W |

AVALANCHE CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| I _{AR} | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T _j max, δ < 1%) | 33 | A |
| E _{AS} | Single Pulse Avalanche Energy (starting T _j = 25 °C, I _D = I _{AR} , V _{DD} = 25 V) | 200 | mJ |

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|---|--|------|------|---------|----------|
| V _{(BR)DSS} | Drain-source Breakdown Voltage | I _D = 250 μA V _{GS} = 0 | 50 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating T _j = 125 °C | | | 1 10 | μA μA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 20 V | | | ± 100 | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} I _D = 1 mA | 2.1 | 3 | 4 | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10V I _D = 19 A | | 0.03 | 0.04 | Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|--|------|-------------------|------|----------------|
| g _{fs} (*) | Forward Transconductance | V _{DS} = 15 V I _D = 19 A | 10 | 17 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25 V f = 1 MHz V _{GS} = 0 | | 2100 260 65 | | pF pF pF |

SWITCHING

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|------|-------------------------|------|----------------------|
| t _{d(on)} t _r t _{d(off)} t _f | Turn-on Time Rise Time Turn-off Delay Time Fall Time | V _{DD} = 30 V I _D = 18 A R _{GS} = 50 Ω V _{GS} = 10 V | | 40 200 220 110 | | ns ns ns ns |

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